PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Rabindra N. Das	09/02/2008
John M. Lauffer	09/02/2008
Irving Memis	09/02/2008
Steven G. Rosser	09/02/2008

RECEIVING PARTY DATA

Name:	Endicott Interconnect Technologies, Inc.
Street Address:	1093 Clark Street
City:	Endicott
State/Country:	NEW YORK
Postal Code:	13760

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12720849

CORRESPONDENCE DATA

 Fax Number:
 (607)723-6605

 Phone:
 6072316830

 Email:
 amanzer@hhk.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

Correspondent Name: Mark Levy, HINMAN, HOWARD & KATTELL, LLP

Address Line 1: 80 Exchange Street
Address Line 2: P.O. Box 5250

Address Line 4: Binghamton, NEW YORK 13901

ATTORNEY DOCKET NUMBER:	EI-2-08-008D
NAME OF SUBMITTER:	Mark Levy, Registration No. 29188

Total Attachments: 1

source=EI-2-08-008D_Assignment#page1.tif

PATENT REEL: 027377 FRAME: 0735

ASSIGNMENT

EI-2-08-008

Whereas, We

- (1) Rabindra N. Das County of Broome
- (2) John M. Lauffer County of Tioga
- (3) Irving (NMN) Memis County of Broome
- (4) Steven G. Rosser County of Tioga

City of Vestal

And State of New York

City of Waverly

And State of New York

City of Vestal

And State of New York

City of Apalachin

And State of New York

have invented certain improvements in Multi-Layer Embedded Capacitance and Resistance Substrate Core and have executed, respectively, a United States patent application therefor on

(1)9/2/2008, (2) 9/2/2008, (3) 9/2/2008, (4) 9/2/2008.

And whereas, ENDICOTT INTERCONNECT TECHNOLOGIES, INC., a corporation of New York, having a place of business at Endicott, New York 13760, (hereinafter called EI), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to EI, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for protection in the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to EI, its successors and assigns; and we hereby agree that EI may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by EI.

Signed:	274
	at Endicott, New York, this 2 Nd day of September, 2008.
	Raldy rate Dan
	Rabindra N. Das
	at Endicott, New York, this 2nd day of September, 2008.
	John Mayler
	SOME IV. LERMINGS V
	at Endicott, New York, this <u>02</u> day of <u>SEPTEMSOR</u> , 2008.
	And menic
	Irving (NMN) Memis
	at Endicott, New York, this <u>OZ</u> day of <u>September</u> , 2008.
	Atom & Rosen
	Steven G. Rosser

PATENT REEL: 027377 FRAME: 0736

RECORDED: 12/13/2011